

Highlights

Deep neural network method for predicting the iron concentration in silicon solar cell by current-voltage characteristic

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Deep neural network method for predicting the iron concentration in silicon solar cell by current-voltage characteristic

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ABSTRACT

Defect-assisted recombination processes frequently limit the photovoltaic device performance. Non-destructive methods of evaluation of the impurities contamination in solar cells, are important from an applied point of view. In this work, we use numerical device simulation to demonstrate the ability to extract impurity contamination from an ideality factor value and utilizing a deep neural network (DNN). The dense layer DNN was trained by using simulation of current-voltage curves of silicon $n^+ - p - p^+$ structure with the following parameters. The iron concentration ranged from 10^{10} to 10^{13} cm⁻³, the base doping level — from 10^{15} to 10^{17} cm⁻³, the base thickness — from 150 to 240 micron, and the temperature — from 290 to 340 K. The structure with interstitial iron atoms only as well as with coexistence of Fe_iB_s pairs and Fe_i was under consideration. It is shown that DNN is able to predict iron concentration with mean squared relative error up to 0.03.

1. Introduction

Metal, especially iron, contamination control remains an important challenge for silicon processing both for microelectronics, logic technologies and solar cells (SCs) [1, 2, 3, 4]. Typically, metal related defect characterization is performed by Fourier-transform infrared spectroscopy, electron-paramagnetic resonance, minority carrier lifetime measurements, deep level transient spectroscopy (DLTS), Laplace DLTS etc [5, 6, 7]. However, these techniques are time-consuming, require special equipment or/and sample preparing. At the same time, the current-voltage (IV) measurement is a standard rapid industrial SC characterization technique. IV characteristics contain important information about electrically active defects [6, 8]. And a few defect diagnostics by IV characteristics are proposed [6, 8, 9, 10, 11]. The temperature dependencies of current components [10, 11] or IV differential parameters [8, 9] are under consideration in the aforesaid methods. But the numerous and high accuracy IV measurements are required in the first and second cases, respectively.

In our previous work [12], we have shown that the SC ideality factor value (n) can be used to estimate the iron concentration (N_{Fe}). It should be noted that the ideality factor is quite often used to characterize the various semiconductor barrier structures [13, 14, 15, 16, 17]. However, a defect's signature in an ideality factor is convoluted with those from so many other physical processes. As a result the obtained analytic expressions $N_{\text{Fe}} = f(n)$ are not general and numerous grading curves are needed to N_{Fe} determination [12].

On the other hand, in the last decade, the deep learning, which is enable to solve problems without clear algorithmization, have been successfully used in various fields of theoretical and applied physics [18, 19, 20]. Furthermore, materials informatics (combination of material property calculations/measurements and informatics algorithms) has been asserted [21] to become the fourth (along with theory, simulations, and experiments) paradigm of science.


This gives hope for an real implementation of aforesaid SC characterization method with using of deep learning approach (so to say "deep learning for deep levels").

studied relationship between the SC ideality factor and the iron concentration.

Any defects detrimental to the device performance should by definition have a signature in the device performance such as current-voltage (JV) measurements. However, such a signal is convoluted with those from so many other physical processes that it cannot be extracted or interpreted through a simple fitting approach, as the fitting would be underconstrained.

The obtained results show that the ideality factor value can be used to estimate the contaminant concentration.

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Non-destructive methods of evaluation of the impurities contamination in semiconductor structures, in particular solar cells (SCs), are important from an applied point of view. To date, a not little collection of direct methods (an infrared tomography, an electron-paramagnetic resonance, a non-stationary spectroscopy, etc.) as well as indirect methods (a surface photovoltage, a minority carrier lifetime measurements) has been developed to solve this problem. But almost all of them require special sample preparing or/and specialized equipment. At the same time, the current-voltage curve (IVC) measurement is a widespread industrial characterization technique and allows to determine a number of fundamental SC parameters. Evidently SC parameters in particular and the processes of carrier propagation in general depend on electrically active defects presence; therefore there is a possibility in principle to determine the impurity concentration by IVC shape. And recent papers demonstrate a novel approach to extract defect properties from inexpensive IV measurements of completed devices [6].

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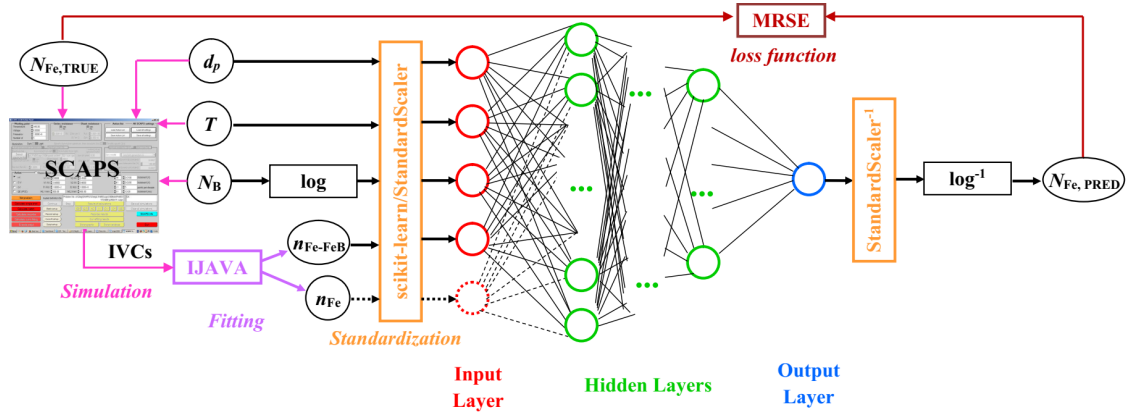


Figure 1: Flowchart of the work steps. Additional details are discussed in the body of the article.

5. Floats

Figures may be included using the command, `\includegraphics` in combination with or without its several options to further control graphic. `\includegraphics` is provided by `graphic[s,x].sty` which is part of any standard \LaTeX distribution. `graphicx.sty` is loaded by default. \LaTeX accepts figures in the postscript format while $\pdf\LaTeX$ accepts *.pdf, *.mps (metapost), *.jpg and *.png formats. $\pdf\LaTeX$ does not accept graphic files in the postscript format.

The `table` environment is handy for marking up tabular material. If users want to use `multirow.sty`, `array.sty`, etc., to fine control/enhance the tables, they are welcome to load any package of their choice and `cas-sc.cls` will work in combination with all loaded packages.

Table 1

This is a test caption. This is a test caption. This is a test caption. This is a test caption.

| Col 1 | Col 2 | Col 3 | Col4 |
|-------|-------|-------|-------|
| 12345 | 12345 | 123 | 12345 |
| 12345 | 12345 | 123 | 12345 |
| 12345 | 12345 | 123 | 12345 |
| 12345 | 12345 | 123 | 12345 |
| 12345 | 12345 | 123 | 12345 |

6. Theorem and theorem like environments

`cas-sc.cls` provides a few shortcuts to format theorems and theorem-like environments with ease. In all commands the options that are used with the `\newtheorem` command will work exactly in the same manner. `cas-sc.cls` provides three commands to format theorem or theorem-like environments:

```

\newtheorem{theorem}{Theorem}
\newtheorem{lemma}[theorem]{Lemma}
\newdefinition{rmk}{Remark}
\newproof{pf}{Proof}
\newproof{pot}{Proof of Theorem \ref{thm2}}

```

The `\newtheorem` command formats a theorem in \LaTeX 's default style with italicized font, bold font for theorem heading and theorem number at the right hand side of the theorem heading. It also optionally accepts an argument which will be printed as an extra heading in parentheses.

```

\begin{theorem}
  For system (8), consensus can be achieved with
   $\|T_{\omega z}\| \dots$ 
  \begin{eqnarray}\label{10}
    \dots
  \end{eqnarray}
\end{theorem}

```

Theorem 1. *For system (8), consensus can be achieved with $\|T_{\omega z}\| \dots$*

....

(1)

The `\newdefinition` command is the same in all respects as its `\newtheorem` counterpart except that the font shape is roman instead of italic. Both `\newdefinition` and `\newtheorem` commands automatically define counters for the environments defined.

The `\newproof` command defines proof environments with upright font shape. No counters are defined.

7. Enumerated and Itemized Lists

`cas-sc.cls` provides an extended list processing macros which makes the usage a bit more user friendly than the default \LaTeX list macros. With an optional argument to the `\begin{enumerate}` command, you can change the list counter type and its attributes.

```

\begin{enumerate}[1.]
\item The enumerate environment starts with an optional
  argument '1.', so that the item counter will be suffixed
  by a period.
\item You can use 'a)' for alphabetical counter and '(i)' for
  roman counter.
\begin{enumerate}[a]
  \item Another level of list with alphabetical counter.
  \item One more item before we start another.
  \item One more item before we start another.
  \item One more item before we start another.
  \item One more item before we start another.
\end{enumerate}

```

Further, the enhanced list environment allows one to prefix a string like 'step' to all the item numbers.

```

\begin{enumerate}[Step 1.]
\item This is the first step of the example list.
\item Obviously this is the second step.
\item The final step to wind up this example.
\end{enumerate}

```

8. Cross-references

In electronic publications, articles may be internally hyperlinked. Hyperlinks are generated from proper cross-references in the article. For example, the words Fig. 1 will never be more than simple text, whereas the proper cross-reference `\ref{tiger}` may be turned into a hyperlink to the figure itself: [Fig. 1](#). In the same way, the words [Ref. \[1\]](#) will fail to turn into a hyperlink; the proper cross-reference is `\cite{Knuth96}`. Cross-referencing is possible in \LaTeX for sections, subsections, formulae, figures, tables, and literature references.

9. Bibliography

Two bibliographic style files (*.bst) are provided — model1-num-names.bst and model2-names.bst — the first one can be used for the numbered scheme. This can also be used for the numbered with new options of natbib.sty. The second one is for the author year scheme. When you use model2-names.bst, the citation commands will be like \citep, \citet, \citealt etc. However when you use model1-num-names.bst, you may use only \cite command.

thebibliography environment. Each reference is a \bibitem and each \bibitem is identified by a label, by which it can be cited in the text:

In connection with cross-referencing and possible future hyperlinking it is not a good idea to collect more than one literature item in one \bibitem. The so-called Harvard or author-year style of referencing is enabled by the L^AT_EX package natbib. With this package the literature can be cited as follows:

- Parenthetical: \citep{WB96} produces (Wettig & Brown, 1996).
- Textual: \citet{ESG96} produces Elson et al. (1996).
- An affix and part of a reference: \citep[e.g.] [Ch. 2]{Gea97} produces (e.g. Governato et al., 1997, Ch. 2).

In the numbered scheme of citation, \cite{<label>} is used, since \citep or \citet has no relevance in the numbered scheme. natbib package is loaded by cas-sc with numbers as default option. You can change this to author-year or harvard scheme by adding option authoryear in the class loading command. If you want to use more options of the natbib package, you can do so with the \biboptions command. For details of various options of the natbib package, please take a look at the natbib documentation, which is part of any standard L^AT_EX installation.

A. My Appendix

Appendix sections are coded under \appendix.

\printcredits command is used after appendix sections to list author credit taxonomy contribution roles tagged using \credit in frontmatter.

CRedit authorship contribution statement

Oleg Olikh: Conceptualization, Methodology, Formal analysis, Data Curation, Writing - Review & Editing, Visualization, Supervision. **Oleg Lozitsky:** Software, Validation, Investigation, Writing - Original Draft. **Oleksii Zavorodnii:** Software, Validation, Formal analysis, Writing - Original Draft.

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